DALLAS SEMICONDUCTOR **МАХIМ**

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FEATURES

- 10-Year Minimum Data Retention in the Absence of External Power
- Data is Automatically Protected During a Power Loss
- Separate Upper Byte and Lower Byte Chip-Select Inputs
- Unlimited Write Cycles
- Low-Power CMOS
- Read and Write Access Times as Fast as 70ns
- Lithium Energy Source is Electrically Disconnected to Retain Freshness Until Power is Applied for the First Time
- Full ±10% Operating Range (DS1258Y)
- Optional ±5% Operating Range (DS1258AB)
- Optional Industrial Temperature Range of -40°C to +85°C, Designated IND

PIN ASSIGNMENT

$\overline{CEU}$	1	40	V_{CC}
$\overline{CEL}$	2	39	$\overline{WE}$
DQ15	3	38	A16
DQ14	4	37	A15
DQ13	5	36	A14
DQ12	6	35	A13
DQ11	7	34	A12
DQ10	8	33	A11
DQ9	9	32	A10
DQ8	10	31	A9
GND	11	30	GND
DQ7	12	29	A8
DQ6	13	28	A7
DQ5	14	27	A6
DQ4	15	26	A5
DQ3	16	25	A4
DQ2	17	24	A3
DQ1	18	23	A2
DQ0	19	22	A1
$\overline{OE}$	20	21	A0

40-Pin Encapsulated Package
740mil Extended

PIN DESCRIPTION

A0 to A16	- Address Inputs
DQ0 to DQ15	- Data In/Data Out
$\overline{CEU}$	- Chip Enable Upper Byte
$\overline{CEL}$	- Chip Enable Lower Byte
$\overline{WE}$	- Write Enable
$\overline{OE}$	- Output Enable
V_{CC}	- Power (+5V)
GND	- Ground

DESCRIPTION

The DS1258 128k x 16 nonvolatile (NV) SRAMs are 2,097,152-bit fully static, NV SRAMs, organized as 131,072 words by 16 bits. Each NV SRAM has a self-contained lithium energy source and control circuitry that constantly monitors V_{CC} for an out-of-tolerance condition. When such a condition occurs, the lithium energy source is automatically switched on and write protection is unconditionally enabled to prevent data corruption. DIP-package DS1258 devices can be used in place of solutions that build NV 128k x 16 memory by utilizing a variety of discrete components. There is no limit on the number of write cycles that can be executed and no additional support circuitry is required for microprocessor interfacing.

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READ MODE

The DS1258 devices execute a read cycle whenever $\overline{WE}$ (Write Enable) is inactive (high) and either/both of $\overline{CEU}$ or $\overline{CEL}$ (Chip Enables) are active (low) and $\overline{OE}$ (Output Enable) is active (low). The unique address specified by the 17 address inputs (A0-A16) defines which of the 131,072 words of data is accessed. The status of $\overline{CEU}$ and $\overline{CEL}$ determines whether all or part of the addressed word is accessed. If $\overline{CEU}$ is active with $\overline{CEL}$ inactive, then only the upper byte of the addressed word is accessed. If $\overline{CEU}$ is inactive with $\overline{CEL}$ active, then only the lower byte of the addressed word is accessed. If both the $\overline{CEU}$ and $\overline{CEL}$ inputs are active (low), then the entire 16-bit word is accessed. Valid data will be available to the 16 data output drivers within t_{ACC} (Access Time) after the last address input signal is stable, providing that $\overline{CEU}$, $\overline{CEL}$ and $\overline{OE}$ access times are also satisfied. If $\overline{CEU}$, $\overline{CEL}$, and $\overline{OE}$ access times are not satisfied, then data access must be measured from the later occurring signal, and the limiting parameter is either t_{CO} for $\overline{CEU}$, $\overline{CEL}$, or t_{OE} for $\overline{OE}$ rather than address access.

WRITE MODE

The DS1258 devices execute a write cycle whenever $\overline{WE}$ and either/both of $\overline{CEU}$ or $\overline{CEL}$ are active (low) after address inputs are stable. The unique address specified by the 17 address inputs (A0-A16) defines which of the 131,072 words of data is accessed. The status of $\overline{CEU}$ and $\overline{CEL}$ determines whether all or part of the addressed word is accessed. If $\overline{CEU}$ is active with $\overline{CEL}$ inactive, then only the upper byte of the addressed word is accessed. If $\overline{CEU}$ is inactive with $\overline{CEL}$ active, then only the lower byte of the addressed word is accessed. If both the $\overline{CEU}$ and $\overline{CEL}$ inputs are active (low), then the entire 16-bit word is accessed. The write cycle is terminated by the earlier rising edge of $\overline{CEU}$ and/or $\overline{CEL}$, or $\overline{WE}$. All address inputs must be kept valid throughout the write cycle. $\overline{WE}$ must return to the high state for a minimum recovery time (t_{WR}) before another cycle can be initiated. The $\overline{OE}$ control signal should be kept inactive (high) during write cycles to avoid bus contention. However, if the output drivers are enabled ($\overline{CEU}$ and/or $\overline{CEL}$, and $\overline{OE}$ active) then $\overline{WE}$ will disable the outputs in t_{ODW} from its falling edge.

READ/WRITE FUNCTION Table 1

$\overline{OE}$	$\overline{WE}$	$\overline{CEL}$	$\overline{CEU}$	V_{CC} CURRENT	DQ0-DQ7	DQ8-DQ15	CYCLE PERFORMED
H	H	X	X	I_{CCO}	High-Z	High-Z	Output Disabled
L	H	L	L		Output	Output	
L	H	L	H	I_{CCO}	Output	High-Z	Read Cycle
L	H	H	L		High-Z	Output	
X	L	L	L		Input	Input	
X	L	L	H	I_{CCO}	Input	High-Z	Write Cycle
X	L	H	L		High-Z	Input	
X	X	H	H	I_{CCS}	High-Z	High-Z	Output Disabled

DATA RETENTION MODE

The DS1258AB provides full functional capability for V_{CC} greater than 4.75V, and write protects by 4.5V. The DS1258Y provides full functional capability for V_{CC} greater than 4.5V and write protects by 4.25V. Data is maintained in the absence of V_{CC} without any additional support circuitry. The NV static RAMs constantly monitor V_{CC}. Should the supply voltage decay, the NV SRAMs automatically write protect themselves, all inputs become "don't care," and all outputs become high impedance. As V_{CC} falls below approximately 3.0V, a power switching circuit connects the lithium energy source to RAM to

retain data. During power-up, when V_{CC} rises above approximately 3.0V, the power switching circuit connects external V_{CC} to RAM and disconnects the lithium energy source. Normal RAM operation can resume after V_{CC} exceeds 4.75V for the DS1258AB and 4.5V for the DS1258Y.

FRESHNESS SEAL

The DS1258 devices are shipped from Dallas Semiconductor with the lithium energy sources disconnected, guaranteeing full energy capacity. When V_{CC} is first applied at a level greater than V_{TP}, the lithium energy source is enabled for battery backup operation.

ABSOLUTE MAXIMUM RATINGS*

Voltage on Any Pin Relative to Ground	-0.3V to +6.0V
Operating Temperature Range	0°C to +70°C, -40°C to +85°C for Industrial Parts
Storage Temperature Range	-40°C to +70°C, -40°C to +85°C for Industrial Parts
Soldering Temperature	See IPC/JEDEC J-STD-020A Specification

* This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS   (t_A: See Note 10)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
DS1258AB Power Supply Voltage	V_{CC}	4.75	5.0	5.25	V	
DS1258Y Power Supply Voltage	V_{CC}	4.5	5.0	5.5	V	
Logic 1	V_{IH}	2.2		V_{CC}	V	
Logic 0	V_{IL}	0.0		+0.8	V	

DC ELECTRICAL CHARACTERISTICS   (V_{CC} = 5V $\pm$ 5% for DS1258AB) (t_A: See Note 10) (V_{CC} = 5V $\pm$ 10% for DS1258Y)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Leakage Current	I_{IL}	-2.0		+2.0	μA	
I/O Leakage Current $\overline{CEU} = \overline{CEL} \geq V_{IH} \leq V_{CC}$	I_{IO}	-1.0		+1.0	μA	
Output Current @ 2.4V	I_{OH}	-1.0			mA	
Output Current @ 0.4V	I_{OL}	2.0			mA	
Standby Current $\overline{CEU}$, $\overline{CEL}$ =2.2V	I_{CCS1}		0.7	1.5	mA	
Standby Current $\overline{CEU}$, $\overline{CEL}$ =V_{CC} - 0.5V	I_{CCS2}		150	300	μA	
Operating Current	I_{CCO1}			170	mA	
Write Protection Voltage (DS1258AB)	V_{TP}	4.50	4.62	4.75	V	
Write Protection Voltage (DS1258Y)	V_{TP}	4.25	4.37	4.5	V	

CAPACITANCE (t_A = +25°C)

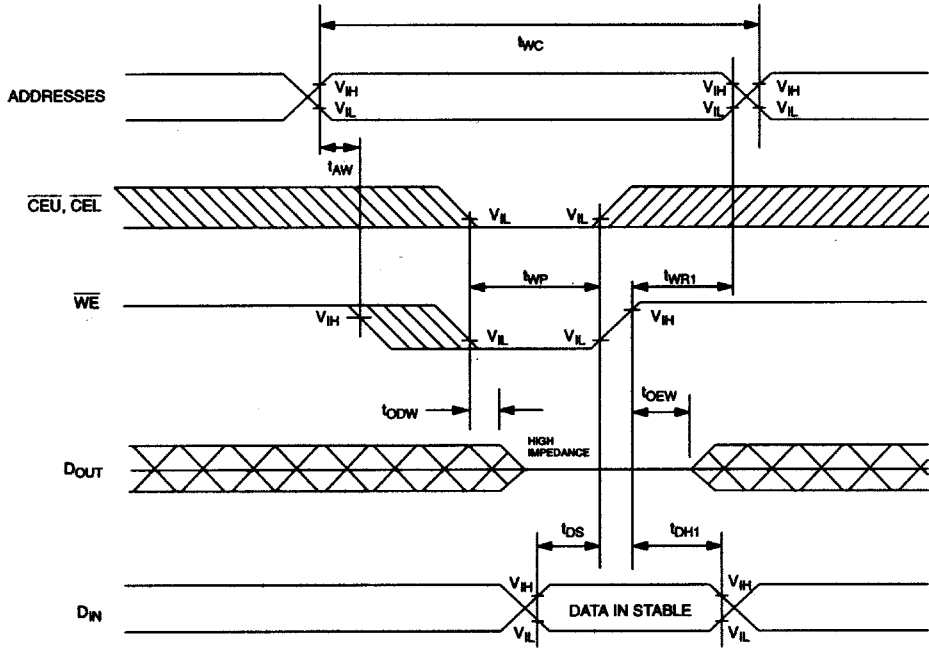| PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Capacitance	C_{IN}		20	25	pF	
Input/Output Capacitance	$C_{I/O}$		5	10	pF	

AC ELECTRICAL CHARACTERISTICS

(V_{CC} = 5V $\pm$ 5% for DS1258AB)
(t_A: See Note 10) (V_{CC} = 5V $\pm$ 10% for DS1258Y)

| PARAMETER	SYMBOL	DS1258AB-70 DS1258Y-70		DS1258AB-100 DS1258Y-100		UNITS	NOTES
		MIN	MAX	MIN	MAX		
Read Cycle Time	t_{RC}	70		100		ns	
Access Time	t_{ACC}		70		100	ns	
$\overline{OE}$ to Output Valid	t_{OE}		35		50	ns	
$\overline{CEU}$ or $\overline{CEL}$ to Output Valid	t_{CO}		70		100	ns	
$\overline{OE}$ or $\overline{CEU}$ or $\overline{CEL}$ to Output Valid	t_{COE}	5		5		ns	5
Output High Z from Deselection	t_{OD}		25		35	ns	5
Output Hold from Address Change	t_{OH}	5		5		ns	
Write Cycle Time	t_{WC}	70		100		ns	
Write Pulse Width	t_{WP}	55		75		ns	3
Address Setup Time	t_{AW}	0		0		ns	
Write Recovery Time	t_{WR1} t_{WR2}	5 15		5 15		ns ns	12 13
Output High Z from $\overline{WE}$	t_{ODW}		25		35	ns	5
Output Active from $\overline{WE}$	t_{OEW}	5		5		ns	5
Data Setup Time	t_{DS}	30		40		ns	4
Data Hold Time	t_{DH1} t_{DH2}	0 10		0 10		ns ns	12 13

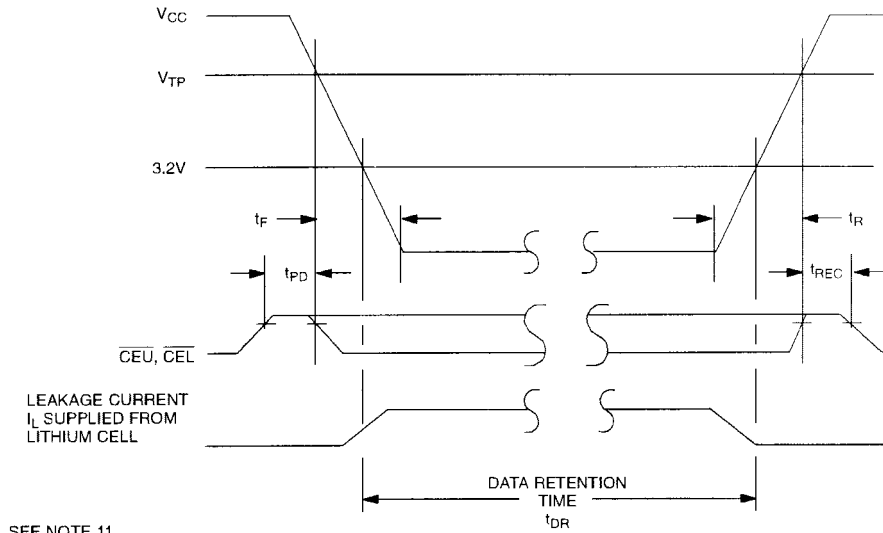## READ CYCLE
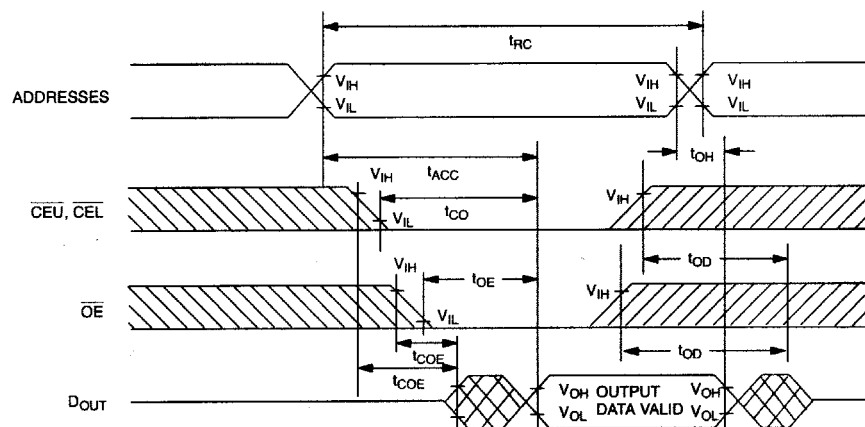
SEE NOTE 1

WRITE CYCLE 1

SEE NOTE 2, 3, 4, 6, 7, 8 AND 12

WRITE CYCLE 2
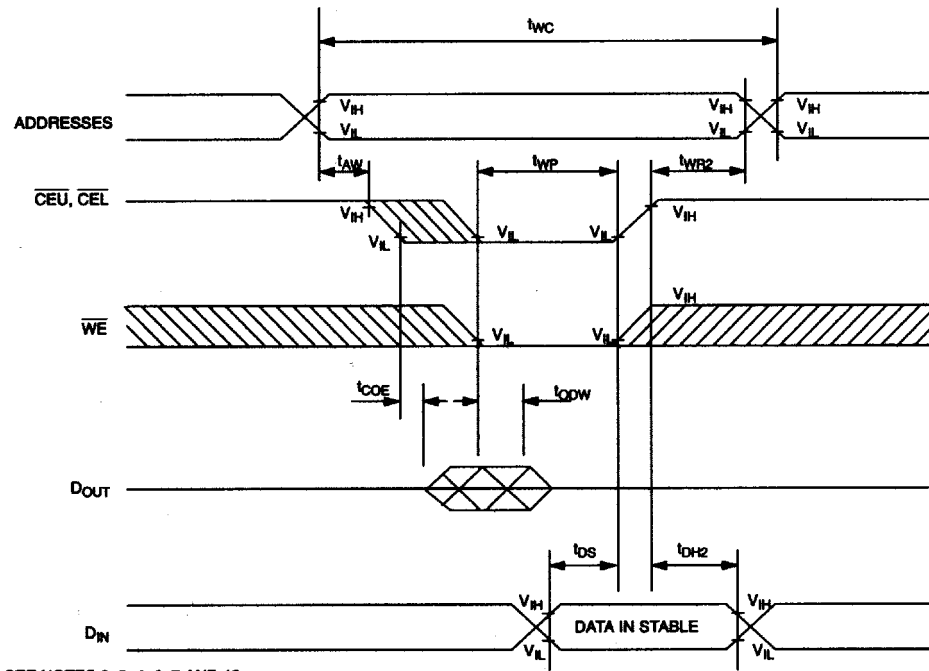
SEE NOTES 2, 3, 4, 6, 7 AND 13

POWER-DOWN/POWER-UP CONDITION

SEE NOTE 11

POWER-DOWN/POWER-UP TIMING $\quad\quad\quad$ (t_A: See Note 10)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
$\overline{CEU}$, $\overline{CEL}$ at V_{IH} before Power-Down	t_{PD}	0			μs	11
V_{CC} slew from V_{TP} to 0V	t_F	300			μs	
V_{CC} slew from 0V to V_{TP}	t_R	300			μs	
$\overline{CEU}$, $\overline{CEL}$ at V_{IH} after Power-Up	t_{REC}	2		125	ms	

(t_A =+25°C)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Expected Data Retention Time	t_{DR}	10			years	9

WARNING:

Under no circumstance are negative undershoots, of any amplitude, allowed when device is in battery backup mode.

NOTES:

1) $\overline{WE}$ is high for a Read Cycle.

2) $\overline{OE}$ = V_{IH} or V_{IL}. If $\overline{OE}$ = V_{IH} during write cycle, the output buffers remain in a high impedance state.

3) t_{WP} is specified as the logical AND of $\overline{CEU}$ or $\overline{CEL}$ and $\overline{WE}$. t_{WP} is measured from the latter of $\overline{CEU}$, $\overline{CEL}$ or $\overline{WE}$ going low to the earlier of $\overline{CEU}$, $\overline{CEL}$ or $\overline{WE}$ going high.

4) t_{DS} is measured from the earlier of $\overline{CEU}$ or $\overline{CEL}$ or $\overline{WE}$ going high.

5) These parameters are sampled with a 5pF load and are not 100% tested.

6) If the $\overline{CEU}$ or $\overline{CEL}$ low transition occurs simultaneously with or later than the $\overline{WE}$ low transition in the output buffers remain in a high impedance state during this period.

7) If the $\overline{CEU}$ or $\overline{CEL}$ high transition occurs prior to or simultaneously with the $\overline{WE}$ high transition, the output buffers remain in high impedance state during this period.

8) If $\overline{WE}$ is low or the $\overline{WE}$ low transition occurs prior to or simultaneously with the $\overline{CEU}$ or $\overline{CEL}$ low transition, the output buffers remain in a high impedance state during this period.

9) Each DS1258 has a built-in switch that disconnects the lithium source until the user first applies V_{CC}. The expected t_{DR} is defined as accumulative time in the absence of V_{CC} starting from the time power is first applied by the user. This parameter is assured by component selection, process control, and design. It is not measured directly during production testing.

10) All AC and DC electrical characteristics are valid over the full operating temperature range. For commercial products, this range is 0°C to +70°C. For industrial products, this range is -40°C to +85°C.

11) In a power-down condition the voltage on any pin may not exceed the voltage on V_{CC}.

12) t_{WR1}, t_{DH1} are measured from $\overline{WE}$ going high.

13) t_{WR2}, t_{DH2} are measured from $\overline{CEU}$ OR $\overline{CEL}$ going high.

14) DS1258 DIP modules are recognized by Underwriters Laboratory (U.L.®) under file E99151.

DC TEST CONDITIONS
Outputs Open
Cycle = 200ns
All voltages are referenced to ground

AC TEST CONDITIONS
Output Load: 100 pF + 1TTL Gate
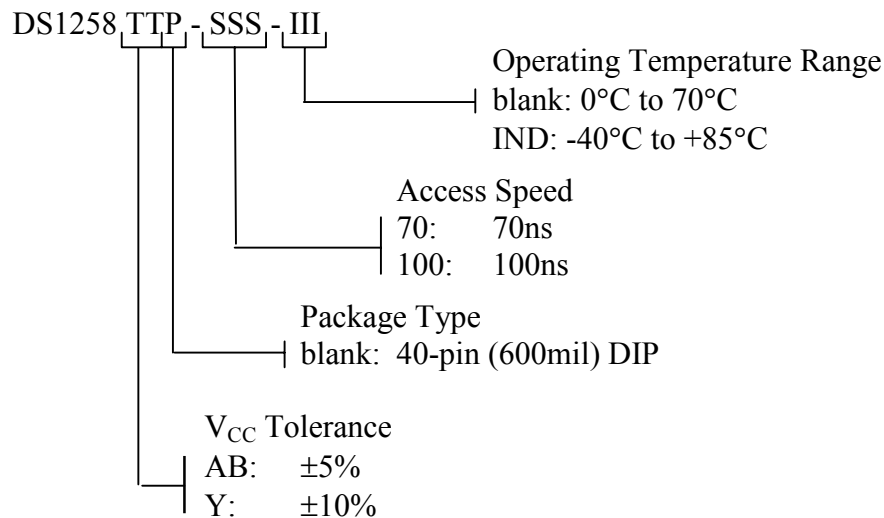Input Pulse Levels:
    0.0V to 3.0V
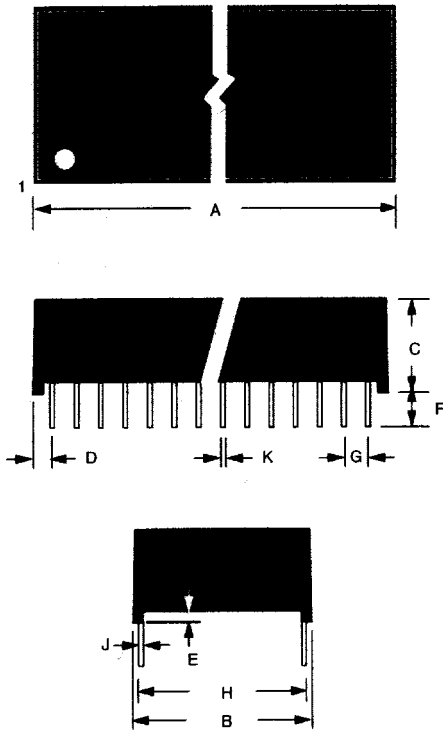Timing Measurement Reference Levels
    Input: 1.5V
    Output: 1.5V
Input pulse Rise and Fall Times: 5ns

ORDERING INFORMATION

DS1258 TTP - SSS - III

Operating Temperature Range
blank: 0°C to 70°C
IND: -40°C to +85°C

Access Speed
70:     70ns
100:    100ns

Package Type
blank: 40-pin (600mil) DIP

V_{CC} Tolerance
AB: ±5%
Y: ±10%

DS1258Y/AB NONVOLATILE SRAM 40-PIN, 740-MIL EXTENDED MODULE

PKG	40-PIN	
DIM	MIN	MAX
A IN.	2.080	2.100
MM	52.83	53.34
B IN.	0.715	0.740
MM	18.16	18.80
C IN.	0.345	0.365
MM	8.76	9.27
D IN.	0.085	0.115
MM	2.16	2.92
E IN.	0.015	0.030
MM	0.38	0.76
F IN.	0.120	0.160
MM	3.05	4.06
G IN.	0.090	0.110
MM	2.29	2.79
H IN.	0.590	0.630
MM	14.99	16.00
J IN.	0.008	0.012
MM	0.20	0.30
K IN.	0.015	0.025
MM	0.43	0.58